WIMA SMD-PPS

Metallized Polyphenylene-Sulphide (PPS) SMD Film Capacitors with Box Encapsulation. Capacitances from 0.01 µF to 2.2 µF. Rated Voltages from 63 VDC to 1000 VDC. Size Codes from 1812 to 6054.

Special Features

- **Size codes 1812, 2220, 2824, 4030,5040 and 6054 with PPS and encapsulated**
- **Operating temperature up to 140° C**
- **Self-healing**
- **Suitable for lead-free soldering**
- **Low dissipation factor**
- **Low dielectric absorption**
- **Very constant capacitance value versus temperature**
- **According to RoHS 2015/863/EU**

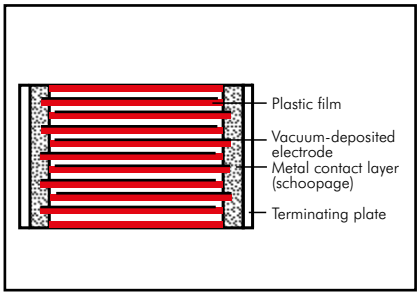
Typical Applications

For general applications in high temperature circuits e.g.

- **By-pass**
- **Blocking**
- **Coupling and decoupling**
- **Timing**
- **Filtering**
- **Oscillating circuits**

Construction

Dielectric:
Polyphenylene-sulphide (PPS) film
Capacitor electrodes:
Vacuum-deposited
Internal construction:



Encapsulation:
Solvent-resistant, flame-retardant plastic case, UL 94 V-0
Terminations:
Tinned plates.
Marking:
Box colour: Black.

Electrical Data

Capacitance range: 0.01 µF to 2.2 µF
Rated voltages:
63 VDC, 100 VDC, 250 VDC, 400 VDC, 630 VDC, 1000 VDC
Capacitance tolerances:
±20%, ±10% (±5% available subject to special enquiry)
Operating temperature range:
–55° C to +140° C
Climatic test category:
55/140/56 in accordance with IEC
Insulation resistance at +20° C:

U_r	U_{test}	C ⩽ 0.33 µF	0.33 µF < C ⩽ 2.2 µF
63 VDC 100 VDC	50 V 100 V	⩾ 1 x 10^4 MΩ	⩾ 3000 sec (MΩ x µF)
⩾ 250 VDC	100 V	⩾ 3 x 10^4 MΩ	⩾ 6000 sec (MΩ x µF)

Measuring time: 1 min.
Dissipation factors at +20° C: tan δ

at f	C ⩽ 0.1 µF	0.1 µF < C ⩽ 1.0 µF	C > 1.0 µF
1 kHz	⩽ 15 x 10^{-4}	⩽ 20 x 10^{-4}	⩽ 20 x 10^{-4}
10 kHz	⩽ 25 x 10^{-4}	⩽ 25 x 10^{-4}	–
100 kHz	⩽ 50 x 10^{-4}	–	–

Maximum pulse rise time:

Capacitance µF	max. pulse rise time V/µsec					
	63 VDC	100 VDC	250 VDC	400 VDC	630 VDC	1000 VDC
0.01 ... 0.022	25	25	30	35	40	45
0.033... 0.068	15	15	20	25	28	32
0.1 ... 0.22	10	10	12	15	–	–
0.33 ... 0.68	5	5	6	8	–	–
1.0 ... 2.2	3	3	–	–	–	–

Dip Solder Test/Processing

Resistance to soldering heat:
Test Tb in accordance with DIN IEC 60068-2-58/DIN EN 60384-20.
Soldering bath temperature max. 260° C.
Soldering duration max. 5 sec.
Change in capacitance ΔC/C < 5 %.
Soldering process:
Re-flow soldering (see temperature/time graphs page 12).

Packing

Available taped and reeled in blister pack.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

Continuation

General Data

Capacitance	63 VDC/40 VAC* Size code	H ±0.3	Part number	100 VDC/63 VAC* Size code	H ±0.3	Part number	250 VDC/160 VAC* Size code	H ±0.3	Part number
0.01 µF	1812	3.0	SMDIC02100KA00____	1812	3.0	SMDID02100KA00____	2220	3.5	SMDIF02100QA00____
	2220	3.5	SMDIC02100QA00____	2220	3.5	SMDID02100QA00____			
0.015 „	1812	3.0	SMDIC02150KA00____	1812	3.0	SMDID02150KA00____	2220	3.5	SMDIF02150QA00____
	2220	3.5	SMDIC02150QA00____	2220	3.5	SMDID02150QA00____			
0.022 „	1812	3.0	SMDIC02220KA00____	1812	3.0	SMDID02220KA00____	2220	3.5	SMDIF02220QA00____
	2220	3.5	SMDIC02220QA00____	2220	3.5	SMDID02220QA00____	2824	3.0	SMDIF02220TA00____
0.033 „	1812	3.0	SMDIC02330KA00____	1812	3.0	SMDID02330KA00____	2824	3.0	SMDIF02330TA00____
	2220	3.5	SMDIC02330QA00____	2220	3.5	SMDID02330QA00____	4030	5.0	SMDIF02330VA00____
	2824	3.0	SMDIC02330TA00____	2824	3.0	SMDID02330TA00____			
0.047 „	1812	3.0	SMDIC02470KA00____	1812	3.0	SMDID02470KA00____	2824	5.0	SMDIF02470TB00____
	2220	3.5	SMDIC02470QA00____	2220	3.5	SMDID02470QA00____	4030	5.0	SMDIF02470VA00____
	2824	3.0	SMDIC02470TA00____	2824	3.0	SMDID02470TA00____			
0.068 „	1812	3.0	SMDIC02680KA00____	2220	3.5	SMDID02680QA00____	2824	5.0	SMDIF02680TB00____
	2220	3.5	SMDIC02680QA00____	2824	3.0	SMDID02680TA00____	4030	5.0	SMDIF02680VA00____
	2824	3.0	SMDIC02680TA00____						
0.1 µF	1812	3.0	SMDIC03100KA00____	2220	3.5	SMDID03100QA00____	2824	5.0	SMDIF03100TB00____
	2220	3.5	SMDIC03100QA00____	2824	3.0	SMDID03100TA00____	4030	5.0	SMDIF03100VA00____
	2824	3.0	SMDIC03100TA00____				5040	6.0	SMDIF03100XA00____
0.15 „	1812	4.0	SMDIC03150KB00____	2824	3.0	SMDID03150TA00____	4030	5.0	SMDIF03150VA00____
	2220	3.5	SMDIC03150QA00____				5040	6.0	SMDIF03150XA00____
	2824	3.0	SMDIC03150TA00____				6054	7.0	SMDIF03150YA00____
0.22 „	2220	4.5	SMDIC03220QB00____	2220	4.5	SMDID03220QB00____	4030	5.0	SMDIF03220VA00____
	2824	5.0	SMDIC03220TB00____	2824	5.0	SMDID03220TB00____	5040	6.0	SMDIF03220XA00____
							6054	7.0	SMDIF03220YA00____
0.33 „	2220	4.5	SMDIC03330QB00____	2824	5.0	SMDID03330TB00____	5040	6.0	SMDIF03330XA00____
	2824	5.0	SMDIC03330TB00____	4030	5.0	SMDID03330VA00____	6054	7.0	SMDIF03330YA00____
	4030	5.0	SMDIC03330VA00____						
0.47 „	2220	4.5	SMDIC03470QB00____	2824	5.0	SMDID03470TB00____	6054	7.0	SMDIF03470YA00____
	2824	5.0	SMDIC03470TB00____	4030	5.0	SMDID03470VA00____			
	4030	5.0	SMDIC03470VA00____						
0.68 „	2824	5.0	SMDIC03680TB00____	4030	5.0	SMDID03680VA00____			
	4030	5.0	SMDIC03680VA00____						
1.0 µF	2824	5.0	SMDIC04100TB00____	5040	6.0	SMDID04100XA00____			
	4030	5.0	SMDIC04100VA00____						
	5040	6.0	SMDIC04100XA00____						
1.5 „	4030	5.0	SMDIC04150VA00____	6054	7.0	SMDID04150YA00____			
	5040	6.0	SMDIC04150XA00____						
2.2 „	6054	7.0	SMDIC04220YA00____	6054	7.0	SMDID04220YA00____			

Part number completion:	
Tolerance:	20 % = M
	10 % = K
	5 % = J
Packing:	bulk = S
Pin length:	none = 00

Taped version see page 150.

* AC voltages: f ⩽ 400 Hz; 1.4 x U_{rms} + UDC ⩽ U_r

Dims. in mm.

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Continuation

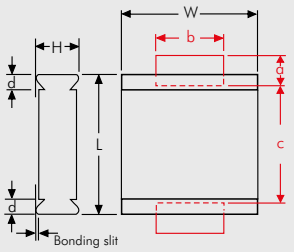
General Data

Capacitance	400 VDC/200 VAC* Size code	H ±0.3	Part number	630 VDC/300 VAC* Size code	H ±0.3	Part number	1000 VDC/400 VAC* Size code	H ±0.3	Part number
0.01 µF				5040	6.0	SMDIJ02100XA00____	5040	6.0	SMDIO12100XA00____
0.015 „				5040	6.0	SMDIJ02150XA00____	5040	6.0	SMDIO12150XA00____
0.022 „	4030 5040	5.0 6.0	SMDIG02220VA00____ SMDIG02220XA00____	5040	6.0	SMDIJ02220XA00____	6054	7.0	SMDIO12220YA00____
0.033 „	4030 5040	5.0 6.0	SMDIG02330VA00____ SMDIG02330XA00____	5040	6.0	SMDIJ02330XA00____	6054	7.0	SMDIO12330YA00____
0.047 „	4030 5040	5.0 6.0	SMDIG02470VA00____ SMDIG02470XA00____	5040	6.0	SMDIJ02470XA00____			
0.068 „	4030 5040	5.0 6.0	SMDIG02680VA00____ SMDIG02680XA00____	6054	7.0	SMDIJ02680YA00____			
0.1 µF	4030 5040 6054	5.0 6.0 7.0	SMDIG03100VA00____ SMDIG03100XA00____ SMDIG03100YA00____						
0.15 „	5040 6054	6.0 7.0	SMDIG03150XA00____ SMDIG03150YA00____						
0.22 „	6054	7.0	SMDIG03220YA00____						
0.33 „	6054	7.0	SMDIG03330YA00____						

* AC voltages: f ⩽ 400 Hz; 1.4 x U_{rms} + UDC ⩽ U_r

Dims. in mm.

Solder pad recommendation



Size code	L ±0.3	W ±0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14

Part number completion:	
Tolerance:	20 % = M
	10 % = K
	5 % = J
Packing:	bulk = S
Pin length:	none = 00
Taped version see page 150.	

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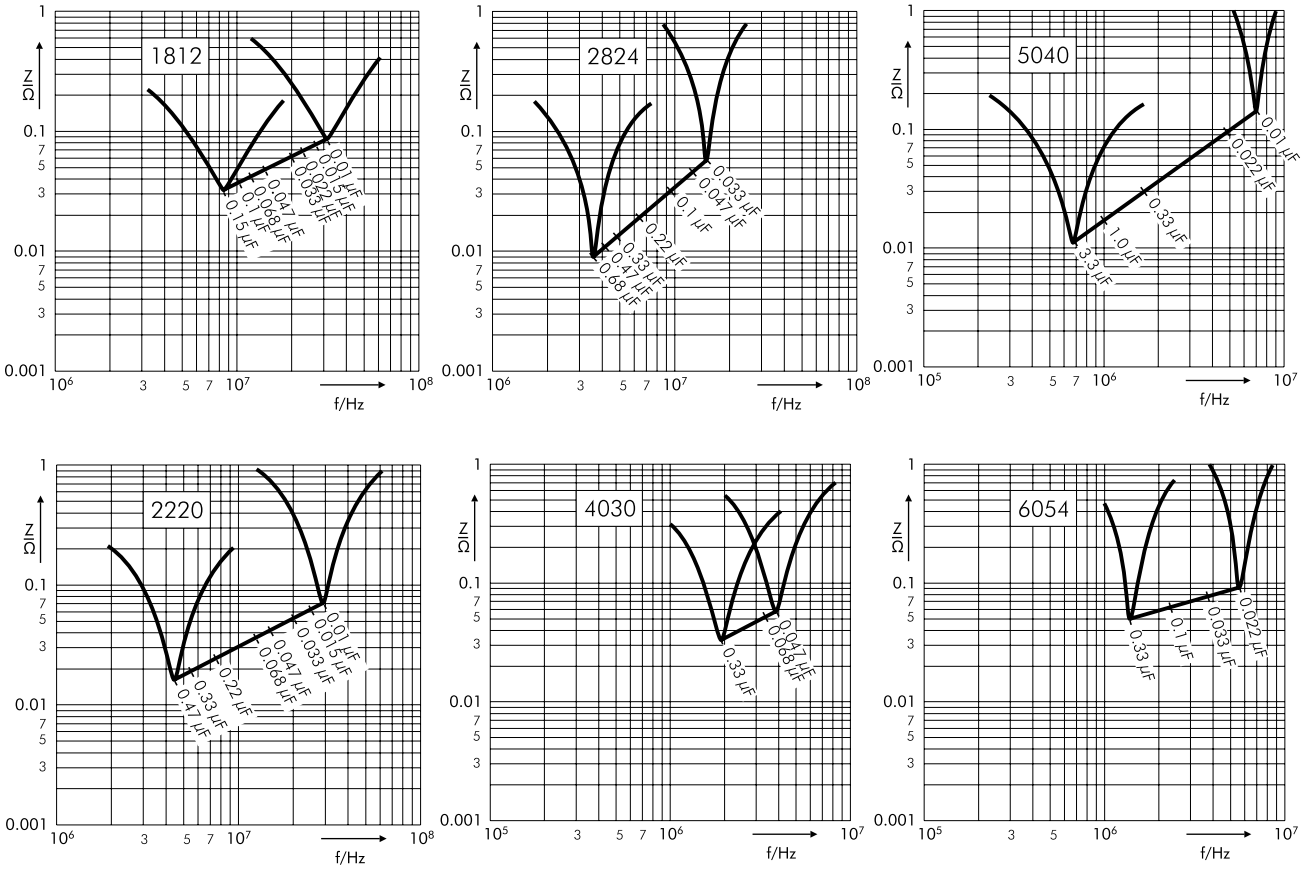
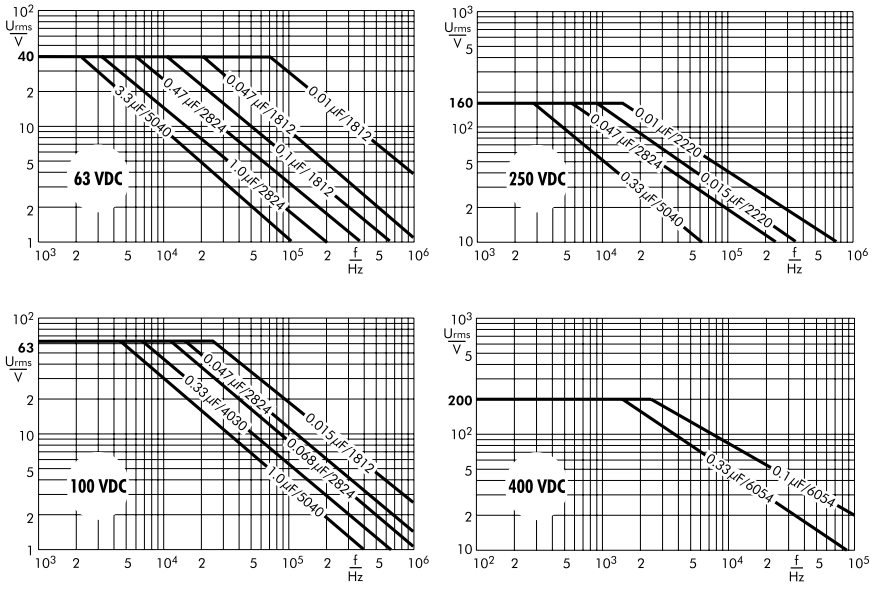
Continuation

Impedance change with frequency (general guide).



Permissible AC voltage in relation to frequency at 10° C internal temperature rise (general guide).

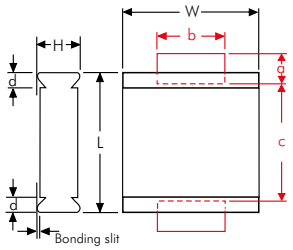


Recommendation for Processing and Application of SMD Capacitors

Layout Form

The components can generally be positioned on the carrier material as desired. In order to prevent soldering shadows or ensure regular temperature distribution, extreme concentration of the components should be avoided. In practice, it has proven best to keep a minimum distance of the soldering surfaces between two WIMA SMDs of twice the height of the components.

Solder Pad Recommendation



Size code	L ± 0.3	W ± 0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14

The solder pad size recommendations given for each individual series are to be understood as minimum dimensions which can at any time be adjusted to the layout form.

Processing

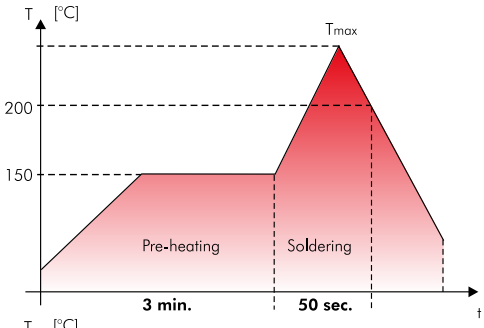
The processing of SMD components

– assembling
– soldering
– electrical final inspection/calibrating

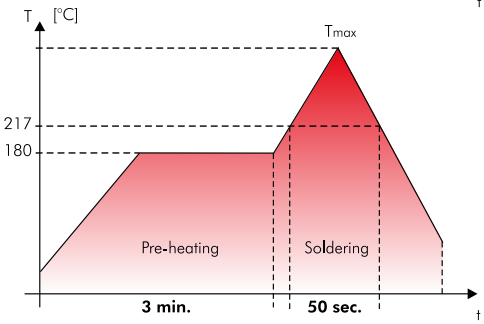
must be regarded as a complete process. The soldering of the printed circuit board, for example, can constitute considerable stress on all the electronic components. The manufacturer's instructions on the processing of the components are mandatory.

Soldering Process

Re-flow soldering



SMD-PET	
Size code	Tmax.
1812	220° C
2220	230° C
2824	230° C
4030	230° C
5040	240° C
6054	250° C



SMD-PPS	
Size code	Tmax.
1812	250° C
2220	250° C
2824	250° C
4030	250° C
5040	250° C
6054	250° C

Temperature/time graph for the permissible processing temperature of the WIMA SMD film capacitor for typical convection soldering processes.

Due to versatile procedures exact processing parameters for re-flow soldering processes cannot be specified. The graph depicted is to be understood as a recommendation to help establishing a suitable soldering profile fulfilling the requirements in practice at the user. During processing a max. temperature of T = 210° C inside the component should not be exceeded. Due to the differing heat absorption the length of the soldering process should be kept as short as possible for smaller size codes.

SMD Handsoldering

WIMA SMD capacitors with plastic film dielectric are generally suitable for hand-soldering, e. g. for lab purposes, with a soldering iron where, however, similar to automated soldering processes, a certain duration and temperature should not be exceeded. These parameters are dependent on the physical size of the components and the relevant heat absorption involved.

The below data are to be regarded as guideline values and should serve to avoid damage to the dielectric caused by excessive heat during the soldering process. The soldering quality depends on the tool used and on the skill and experience of the person with the soldering iron in hand.

Size code	Temperature °C / °F	Time duration
1812	250/482	2 sec plate 1 / 5 sec off / 2 sec plate 2
2220	250/482	3 sec plate 1 / 5 sec off / 3 sec plate 2
2824	260/500	3 sec plate 1 / 5 sec off / 3 sec plate 2
4030	260/500	5 sec plate 1 / 5 sec off / 5 sec plate 2
5040	260/500	5 sec plate 1 / 5 sec off / 5 sec plate 2
6054	260/500	5 sec plate 1 / 5 sec off / 5 sec plate 2

Recommendation for Processing and Application of SMD Capacitors (Continuation)

Solder Paste

To achieve reliable soldering results one of the following solder alloys have from case to case proven being workable:

Lead free solder paste
Sn - Bi
Sn - Zn (Bi)
Sn - Ag - Cu (suitable for SMD-PET 5040/6054, SMD-PEN and SMD-PPS)

Solder paste with lead
Sn - Pb - Ag (Sn60-Pb40-A, Sn63-Pb37-A)

Washing

WIMA SMD components with plastic encapsulation - like all other components of similar construction irrespective of the make - cannot be regarded as hermetically sealed. Due to today's common washing substances, e. g. on aqueous basis instead of the formerly used halogenated hydrocarbons, with enhanced washing efficiency it became obvious that assembled SMD capacitors may show an impermissibly high deviation of the electrical parameters after a corresponding washing process. Hence it is recommended to refrain from applying industrial washing processes for WIMA SMD capacitors in order to avoid possible damages.

Initial Operation/Calibration

Due to the stress which the components are subjected to during processing, reversible parameter changes occur in almost all electronic components. The capacitance recovery accuracy to be expected with careful processing is within a scope of

$|\Delta C/C| \leqslant 5\ \%$.

For the initial operation of the device a minimum storage time of

$t \geqslant 24$ hours

is to be taken into account. With calibrated devices or when the application is largely dependent on capacitance it is advisable to prolong the storage time to

$t \geqslant 10$ days

In this way ageing effects of the capacitor structure can be anticipated. Parameter changes due to processing are not to be expected after this period of time

Humidity Protection Bags

Taped WIMA SMD capacitors are shipped in humidity protection bags according to JEDEC standard (ESD/EMI-shield/water-vapour proof).
Under controlled conditions the components can be stored two years and more in the originally sealed bag. Opened packing units should immediately be used up for processing. If storage is necessary the opened packing units should be stored air-tight in the original plastic bag.

Reliability

Taking account of the manufacturer's guidelines and compatible processing, the WIMA SMD stand out for the same high quality and reliability as the analogous through-hole WIMA series. The technology of metallized film capacitors used e.g. in WIMA SMD-PET achieves the best values for all fields of application. The expected value is about:

$\lambda_0 \leqslant 2$ fit

Furthermore the production of all WIMA components is subject to the regulations laid down by ISO 9001:2015 as well as the guidelines for component specifications set out by IEC quality assessment system (IECQ) for electronic components.

Electrical Characteristics and Fields of Application

Basically the WIMA SMD series have the same electrical characteristics as the analogous through-hole WIMA capacitors. Compared to ceramic or tantalum dielectrics WIMA SMD capacitors have a number of other outstanding qualities:

- **favourable pulse rise time**
- **low ESR**
- **low dielectric absorption**
- **available in high voltage series**
- **large capacitance spectrum**
- **stand up to high mechanical stress**
- **good long-term stability**

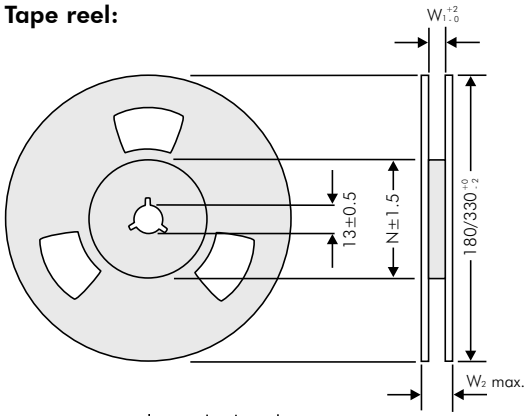
As regards technical performance as well as quality and reliability, the WIMA SMD series offer the possibility to cover nearly all applications of conventionally through-hole film capacitors with SMD components. Furthermore, the WIMA SMD series can now be used for all the demanding capacitor applications for which, in the past, the use of through-hole components was mandatory:

- **measuring techniques**
- **oscillator circuits**
- **differentiating and integrating circuits**
- **A/D or D/A transformers**
- **sample and hold circuits**
- **automotive electronics**

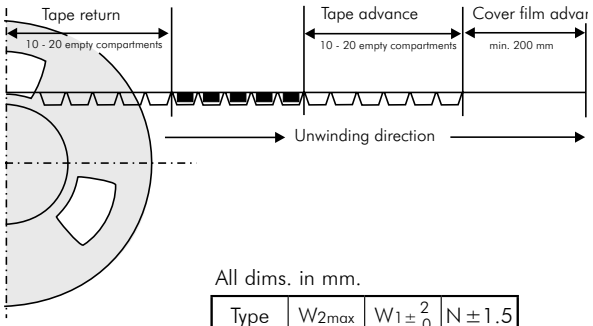
With the WIMA SMD programme available today, the major part of all plastic film capacitors can be replaced by WIMA SMD components. The field of application ranges from standard coupling capacitors to use in switch-mode power supplies as filter or charging capacitors with high voltage and capacitance values, as well as in telecommunications e.g. the well-known telephone capacitor 1µF/250VDC.

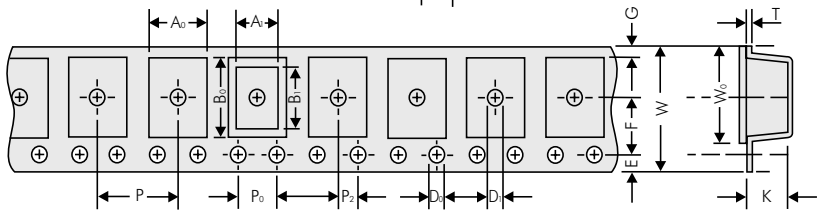
Blister Tape Packaging and Packing Units of the WIMA SMD Capacitors

Tape reel:



Tape advance and return:





All dims. in mm.

Type	W2max	W1 ± 2 0	N ± 1.5
1812	19	12.4	62
2220	19	12.4	62
2824	19	12.4	62
4030	22.4	16.4	60
5040	30.4	24.4	90
6054	30.4	24.4	90

Packing units

Size Code 1812		A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1
Box size	Code																
4.8x3.3x3	**KA**	3.55	3.3	5.1	4.8	P1.5	P1.5	8	4	2	1.75	5.5	2.2	12	9.5	3.4	0.3
4.8x3.3x4	**KB**	3.55	3.3	5.1	4.8	P1.5	P1.5	8	4	2	1.75	5.5	2.2	12	9.5	4.4	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk Standard
700	2500	3000
500	2000	3000

Size Code 2220		A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1
Box size	Code																
5.7x5.1x3.5	**QA**	6.3	5.7	5.6	5.1	P1.5	P1.5	8	4	2	1.75	5.5	1.95	12	9.5	3.7	0.3
5.7x5.1x4.5	**QB**	6.3	5.7	5.6	5.1	P1.5	P1.5	8	4	2	1.75	5.5	1.95	12	9.5	4.7	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk Standard
500	1800	3000
400	1500	3000

Size Code 2824		A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1
Box size	Code																
7.2x6.1x3	**TA**	6.6	6.1	7.7	7.2	P1.5	P1.5	12	4	2	1.75	5.5	0.9	12	9.5	3.4	0.3
7.2x6.1x5	**TB**	6.6	6.1	7.7	7.2	P1.5	P1.5	12	4	2	1.75	5.5	0.9	12	9.5	5.4	0.4

taped Reel 330 mm Ø	bulk Standard
1500	2000
750	2000

	Code	A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1
Size Code 4030	**VA**	10.7	10.2	8.1	9.1	P1.5	P1.5	16	4	2	1.75	7.5	1.9	16	13.3	5.5	0.3
Size Code 5040	**XA**	13.5	12.7	11	11.5	P1.5	P1.5	16	4	2	1.75	11.5	4.7	24	21.3	6.5	0.3
Size Code 6054	**YA**	17.0	16.5	15.6	15.0	P1.5	P1.5	20	4	2	1.75	11.5	2.95	24	21.3	7.5	0.3

taped Reel 330 mm Ø	bulk Standard
775	2000
600	1000
450	500

* cumulative after 10 steps p 0.2 mm max.
Samples and pre-production needs on request or 1 Reel minimum.

Part number codes for SMD packing

W (Blister)	Ø in mm	Code
12	180	**P**
12	330	**Q**
16	330	**R**
24	330	**T**

Bulk Standard	**S**

05.25

WIMA Part Number System

A WIMA part number consists of 18 digits and is composed as follows:

Field 1 - 4: Type description
Field 5 - 6: Rated voltage
Field 7 - 10: Capacitance
Field 11 - 12: Size and PCM
Field 13 - 14: Version code (e.g. Snubber versions)
Field 15: Capacitance tolerance
Field 16: Packing
Field 17 - 18: Pin length (untaped)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
M	**K**	**S**	**2**	**C**	**0**	**2**	**1**	**0**	**0**	**1**	**A**	**0**	**0**	**M**	**S**	**S**	**D**
MKS 2				63 VDC		0.01 µF				2.5x6.5x7.2		-		20%	bulk	6 -2	

Type description:

SMD-PET	= SMDT
SMD-PPS	= SMDI
FKP 02	= FKP0
MKS 02	= MKS0
FKS 2	= FKS2
FKP 2	= FKP2
FKS 3	= FKS3
FKP 3	= FKP 3
MKS 2	= MKS2
MKP 2	= MKP2
MKS 4	= MKS4
MKP 4	= MKP4
MKP 10	= MKP1
FKP 4	= FKP4
FKP 1	= FKP1
MKP-X2	= MKX2
MKP-X1 R	= MKX1
MKP-Y2	= MKY2
MKP 4F	= MKPF
Snubber MKP	= SNMP
Snubber FKP	= SNFP
GTO MKP	= GTOM
DC-LINK MKP 4	= DCP4
DC-LINK MKP 6	= DCP6
DC-LINK HC	= DCHC

Rated voltage:

50 VDC	= B0
63 VDC	= C0
100 VDC	= D0
250 VDC	= F0
400 VDC	= G0
450 VDC	= H0
520 VDC	= H2
600 VDC	= I0
630 VDC	= J0
700 VDC	= K0
800 VDC	= L0
850 VDC	= M0
900 VDC	= N0
1000 VDC	= O1
1100 VDC	= P0
1200 VDC	= Q0
1250 VDC	= R0
1500 VDC	= S0
1600 VDC	= T0
1700 VDC	= TA
2000 VDC	= U0
2500 VDC	= V0
3000 VDC	= W0
4000 VDC	= X0
6000 VDC	= Y0
230 VAC	= 3Y
275 VAC	= 1W
300 VAC	= 2W
305 VAC	= AW
350 VAC	= BW
440 VAC	= 4W
...	

Capacitance:

22 pF	= 0022
47 pF	= 0047
100 pF	= 0100
150 pF	= 0150
220 pF	= 0220
330 pF	= 0330
470 pF	= 0470
680 pF	= 0680
1000 pF	= 1100
1500 pF	= 1150
2200 pF	= 1220
3300 pF	= 1330
4700 pF	= 1470
6800 pF	= 1680
0.01 µF	= 2100
0.022 µF	= 2220
0.047 µF	= 2470
0.1 µF	= 3100
0.22 µF	= 3220
0.47 µF	= 3470
1 µF	= 4100
2.2 µF	= 4220
4.7 µF	= 4470
10 µF	= 5100
22 µF	= 5220
47 µF	= 5470
100 µF	= 6100
220 µF	= 6220
1000 µF	= 7100
1500 µF	= 7150
...	

Size:

4.8x3.3x3 Size 1812	= KA
4.8x3.3x4 Size 1812	= KB
5.7x5.1x3.5 Size 2220	= QA
5.7x5.1x4.5 Size 2220	= QB
7.2x6.1x3 Size 2824	= TA
7.2x6.1x5 Size 2824	= TB
10.2x7.6x5 Size 4030	= VA
12.7x10.2x6 Size 5040	= XA
15.3x13.7x7 Size 6054	= YA
2.5x7x4.6 PCM 2.5	= 0B
3x7.5x4.6 PCM 2.5	= 0C
2.5x6.5x7.2 PCM 5	= 1A
3x7.5x7.2 PCM 5	= 1B
2.5x7x10 PCM 7.5	= 2A
3x8.5x10 PCM 7.5	= 2B
3x9x13 PCM 10	= 3A
4x9x13 PCM 10	= 3C
5x11x18 PCM 15	= 4B
6x12.5x18 PCM 15	= 4C
5x14x26.5 PCM 22.5	= 5A
6x15x26.5 PCM 22.5	= 5B
9x19x31.5 PCM 27.5	= 6A
11x21x31.5 PCM 27.5	= 6B
9x19x41.5 PCM 37.5	= 7A
11x22x41.5 PCM 37.5	= 7B
19x31x56 PCM 48.5	= 8D
25x45x57 PCM 52.5	= 9D
...	

Version code:

Standard	= 00
Version A1	= 1A
Version A1.1.1	= 1B
Version A2	= 2A
...	

Tolerance:

±20%	= M
±10%	= K
±5%	= J
±2.5%	= H
±1%	= E
...	

Packing:

AMMO H16.5 340x340	= A
AMMO H16.5 490x370	= B
AMMO H18.5 340x340	= C
AMMO H18.5 490x370	= D
REEL H16.5 360	= F
REEL H16.5 500	= H
REEL H18.5 360	= I
REEL H18.5 500	= J
ROLL H16.5	= N
ROLL H18.5	= O
BLISTER W12 180	= P
BLISTER W12 330	= Q
BLISTER W16 330	= R
BLISTER W24 330	= T
Bulk/TPS Standard	= S
...	

Pin length (untaped)

3.5 ±0.5	= C9
6 -2	= SD
16 ±1	= P1
...	

Pin length (taped)

none	= 00

The data on this page is not complete and serves only to explain the part number system. Part number information is listed on the pages of the respective WIMA range.